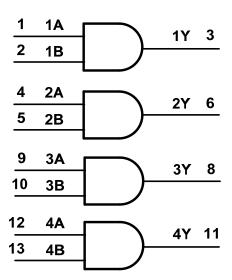


Pin Descriptions

Pin Number	Pin Name	Function
1	1A	Data Input
2	1B	Data Input
3	1Y	Data Output
4	2A	Data Input
5	2B	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	3B	Data Input
11	4Y	Data Output
12	4A	Data Input
13	4B	Data Input
14	Vcc	Supply Voltage

Logic Diagram



Function Table

Inp	Output	
Α	В	Y
L	L	L
L	Н	L
Н	L	L
Н	Н	Н



Absolute Maximum Ratings (Note 4) (@TA = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range (Note 5)	-0.5 to +7.0	V
I _{IK}	Input Clamp Current $V_I < -0.5V$ or $V_{CC} + 0.5V$	±20	mA
lok	Output Clamp Current V _O < -0.5V or V _O > V _{CC} +0.5V	±20	mA
Io	Continuous output current -0.5V < V _O V _{CC} +0.5V	+/- 25	mA
Icc	Continuous current through V _{CC}	50	mA
I _{GND}	Continuous current through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Notes:

Recommended Operating Conditions (Note 6) (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage		2.0	6.0	V
VI	Input Voltage		0	V _{CC}	V
Vo	Output Voltage		0	V _{CC}	V
		$V_{CC} = 2.0V$	_	625	
Δt/ΔV	Input Transition Rise or Fall Rate	V_{CC} = 4.5 V	_	140	ns/V
		$V_{CC} = 6.0V$	_	85	
T _A	Operating Free-Air Temperature		-40	+125	°C

Note: 6. Unused inputs should be held at V_{CC} or Ground.

^{4.} Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

^{5.} Input Voltage cannot exceed V_{CC} to the extent the Maximum clamp current is exceeded



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Cumbal	Dovomotov	Test Conditions	V	T _A = -40°	C to +85°C	T _A = -40°C	to +125°C	Unit
Symbol	Parameter	rest Conditions	V _{CC}	Min	Max	Min	Max	Unit
			2.0V	1.5	_	1.5	_	
V_{IH}	High-level Input Voltage		4.5V	3.15	_	3.15	_	V
			6.0V	4.2	_	4.2	_	
			2.0V	_	0.5	_	0.5	
V_{IL}	Low-level Input Voltage		4.5V	_	1.35	_	1.35	V
			6.0V	_	1.8		1.8	
		$I_{OH} = -20 \mu A$	2.0V	1.9	_	1.9	_	
		$I_{OH} = -20 \mu A$	4.5V	4.4	_	4.4	_	V
V _{OH}	High-level Output Voltage	I _{OH} = -20μA	6.0V	5.9	_	5.9	_	
		I _{OH} = -4.0mA	4.5V	3.84	_	3.7	_	
		I _{OH} = -5.2mA	6.0V	5.34	_	5.2	_	
		I _{OL} = 20μA	2.0V	_	0.1	_	0.1	
		$I_{OL} = 20\mu A$	4.5V	_	0.1	_	0.1	
V_{OL}	Low-level Output Voltage	I _{OL} = 20μA	6.0V	_	0.1	_	0.1	V
		I _{OL} = 4mA	4.5V	_	0.33	_	0.44	1
		I _{OL} = 5.2 mA	6.0V	_	0.33	_	0.44	
II	Input Current	V _I =GND to 5.5V	6.0V	_	± 1	_	± 1	μΑ
I _{CC}	Supply Current	$V_I = GND \text{ or } V_{CC},$ $I_O = 0$	6.0V	_	20	_	40	μА

Switching Characteristics

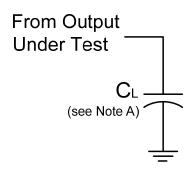
Symbol	mbol Barameter Test		Parameter Test		Test Vcc		T _A = +25°0	3	-40°C to +85°C	-40°C to +125°C	Unit
Syllibol	Farameter	Conditions	VCC	Min	Тур.	Max	Max	Max	Oilit		
	Description	Figure 1	2.0V	_	25	90	115	125			
t_{PD}	Propagation Delay A _N to Y _N	Figure 1 $C_L = 50pF$	4.5V	_	9	18	23	27	ns		
	Delay AN IO IN	CL = 50PF	6.0V	_	7	15	20	23			
		Figure 1	2.0V	_	19	75	95	110			
t _t Transition Time	Figure 1 - C _L = 50pF -	4.5V	_	7	15	19	22	ns			
		CL = 30pi	6.0V	_	6	13	16	19			

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

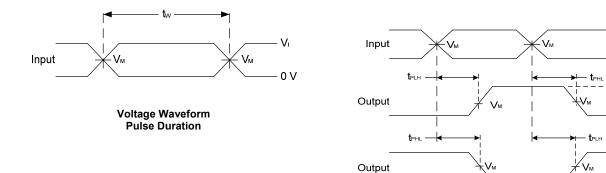
Parameter		Test Conditions	V _{CC} = 6V Typ	Unit
C _{pd}	Power Dissipation Capacitance per Gate	f = 1 MHz	20	pF
Cı	Input Capacitance	$V_1 = V_{CC} - \text{or GND}$	4	pF



Parameter Measurement Information



V _{CC}	lnı	outs	V _M	CL	
	VI	t _r /t _f			
2.0V to 6.0V	V _{CC}	6ns	V _{CC} /2	15pF,50pF	



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

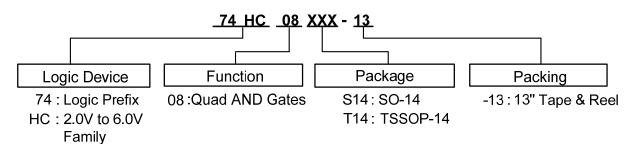
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 1 MHz
- C. Inputs are measured separately one transition per measurement
- D. t_{PLH} and t_{PHL} are the same as t_{PD}

Figure 1 Load Circuit and Voltage Waveforms



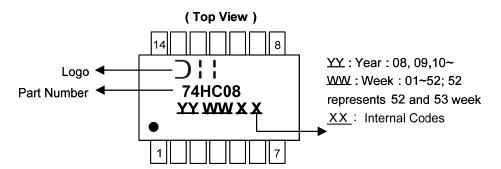
Ordering Information



	Davisa	Backage Code	Dookoging	7" Тар	e and Reel
	Device	Package Code	Packaging	Quantity	Part Number Suffix
Lead-free Green	74HC08S14-13	S14	SO-14	2500/Tape & Reel	-13
Pb Lead free Green	74HC08T14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Marking Information

(1) SO-14, TSSOP-14



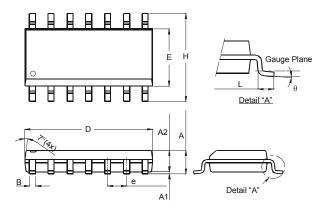
Part Number	Package
74HC08S14	SO-14
74HC08T14	TSSOP-14



Package Outline Dimensions (All dimensions in mm.)

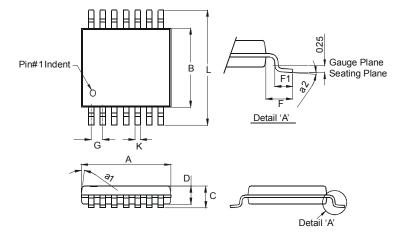
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

Package Type: SO-14



	SO-14	
Dim	Min	Max
Α	1.47	1.73
A1	0.10	0.25
A2	1.45	Тур
В	0.33	0.51
D	8.53	8.74
Е	3.80	3.99
е	1.27	Тур
Н	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Di	mensions	s in mm

Package Type: TSSOP-14

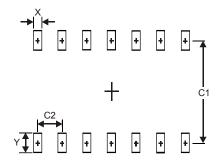


	TSSOP-14					
Dim	Dim Min Max					
a1	7° (4X)				
a2	0°	8°				
Α	4.9	5.10				
В	4.30	4.50				
С	_	1.2				
D	0.8	1.05				
F	1.00	Тур				
F1	0.45	0.75				
G	G 0.65 Typ					
K	0.19	0.30				
L	6.40 Typ					
All Dir	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.

Package Type: SO-14

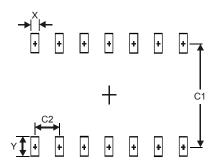


Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27



Suggested Pad Layout (cont.)

Package Type: TSSOP-14



Value (in mm)
0.45
1.45
5.9
0.65

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